

2SK3140-VB Datasheet N-Channel 60 V (D-S) MOSFET

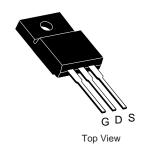
PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a		
60	0.003 at V _{GS} = 10 V	210		
00	0.005 at V _{GS} = 4.5 V	185		

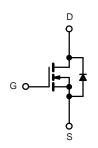
FEATURES

- 175 °C Junction Temperature
- Trench Power MOSFET
- Material categorization:









N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_C = 3$	25 °C, unless othe	rwise noted)		
Parameter		Symbol	Limit	Unit
Gate-Source Voltage		V _{GS}	± 20	V
Continuous Prois Current /T 175 °C\b	T _C = 25 °C	I.	210	
Continuous Drain Current (T _J = 175 °C) ^b	T _C = 100 °C	l l _D	185 ^a	
Pulsed Drain Current		I _{DM}	200	A
Continuous Source Current (Diode Conduction)		I _S	180 ^a	1
Avalanche Current		I _{AS}	70	1
Single Avalanche Energy (Duty Cycle ≤ 1 %)	L = 0.1 mH	E _{AS}	125	mJ
Maximum Dayyar Dissination	T _C = 25 °C	P _D	136	w
Maximum Power Dissipation	T _A = 25 °C		3 ^b , 8.3 ^{b, c}] vv
Operating Junction and Storage Temperature Range	<u>. </u>	T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Manianum lumation to Ambienti	t ≤ 10 sec	D.	15	18	°C/W		
Maximum Junction-to-Ambient ^a	Steady State	R_{thJA}	40	50			
Maximum Junction-to-Case		R _{thJC}	0.85	1.1			

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. $t \le 10 \text{ s}$.

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SPECIFICATIONS ($T_J = 25$	°C, unless o	otherwise noted)					
Parameter	Symbol	Test Conditions	Min.	Typ.a	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	2	3	V nA μA A S pF nC nS	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V _{DS} = 60 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V, T _J = 125 °C			50	μA	
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 \text{ °C}$			250		
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	60			Α	
		V _{GS} = 10 V, I _D = 20 A		0.003			
Due to Occurre October Destruction	P	V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.008		Ω	
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 175 °C		0.010			
		V _{GS} = 4.5 V, I _D = 15 A		0.005		S	
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		60		S	
Dynamic							
Input Capacitance	C _{iss}			2650			
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		470		pF	
Reverse Transfer Capacitance	C _{rss}			225			
Total Gate Charge ^c	Q_g			47	70		
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$		10		nC	
Gate-Drain Charge ^c	Q_{gd}			12		1	
Turn-On Delay Time ^c	t _{d(on)}			10	20		
Rise Time ^c	t _r	$V_{DD} = 30 \text{ V}, R_{L} = 0.6 \Omega$		15	25	20	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		35	50	ns	
Fall Time ^c	t _f			20	30		
Source-Drain Diode Ratings and Cha	aracteristics (T _C = 25 °C)					
Pulsed Current	I _{SM}				60	Α	
Diode Forward Voltage	V_{SD}	$I_F = 20 \text{ A}, V_{GS} = 0 \text{ V}$		1	1.5	V	
Reverse Recovery Time	t _{rr}	I _F = 20 A, di/dt = 100 A/μs		45	100	ns	

Notes:

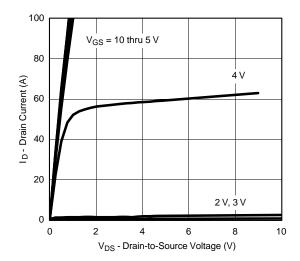
- a. For design aid only; not subject to production testing.
- b. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

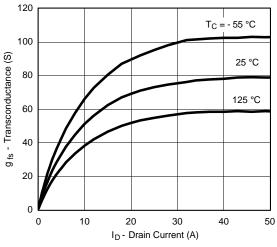
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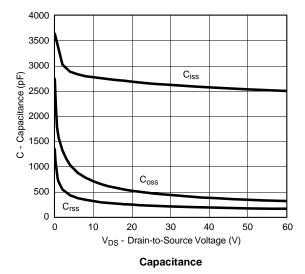
TYPICAL CHARACTERISTICS (25 °C unless noted)



Output Characteristics

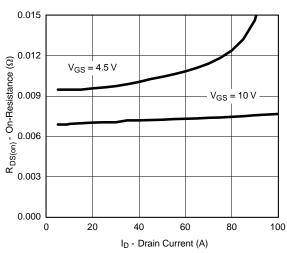


Transconductance

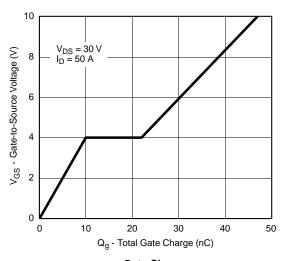


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Transfer Characteristics



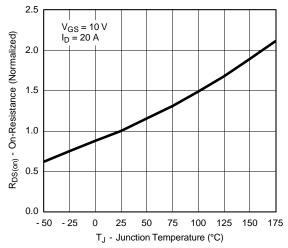
On-Resistance vs. Drain Current



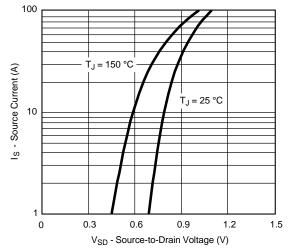
Gate Charge



TYPICAL CHARACTERISTICS (25 °C unless noted)



On-Resistance vs. Junction Temperature

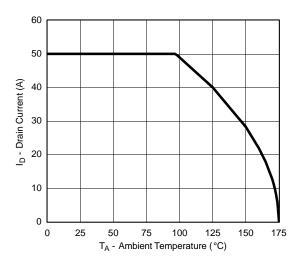


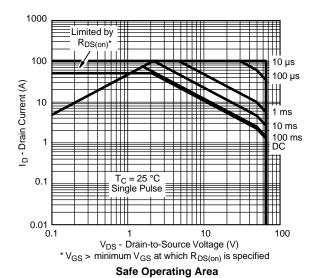
Source-Drain Diode Forward Voltage

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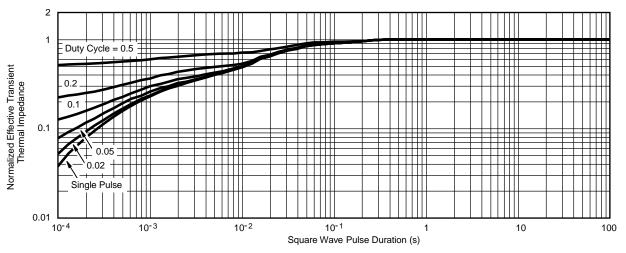


THERMAL RATINGS





Maximum Drain Current vs. Ambient Temperature



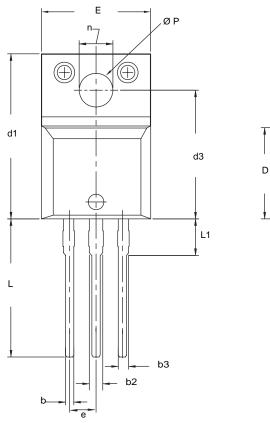
Normalized Thermal Transient Impedance, Junction-to-Case

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TO-220 FULLPAK (HIGH VOLTAGE)



DIM.	MILLIN	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.		
A	4.570	4.830	0.180	0.190		
A1	2.570	2.830	0.101	0.111		
A2	2.510	2.850	0.099	0.112		
b	0.622	0.890	0.024	0.035		
b2	1.229	1.400	0.048	0.055		
b3	1.229	1.400	0.048	0.055		
С	0.440	0.629	0.017	0.025		
D	8.650	9.800	0.341	0.386		
d1	15.88	16.120	0.622	0.635		
d3	12.300	12.920	0.484	0.509		
E	10.360	10.630	0.408	0.419		
е	2.54	BSC	0.100) BSC		
L	13.200	13.730	0.520			
L1	3.100	3.500	0.122	0.138		
n	6.050	6.150	0.238	0.242		
ØΡ	3.050	3.450	0.120	0.136		
u	2.400	2.500	0.094	0.098		
V	0.400	0.500	0.016	0.020		

DWG: 5972

Notes

- To be used only for process drawing.
 These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads.
 All critical dimensions should C meet C_{pk} > 1.33.
 All dimensions include burrs and plating thickness.

- 5. No chipping or package damage.

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